SPECIFICATION(Draft)	SPEC. I	No. C473NA	A00103 ISSUE 1
		DATE		ber 27, 2018
To FOXTAR		-		
CUSTOMER'S PRODUCT NA		K'S PRO		AME
		VLBS	1007050T	-R20M
RECEIPT CONFIRMATION				
	DATE	YEAI	R MO	NTH DAY
TDK Corporation				
SalesEngineeringElectronic ComponentsTDK CorporationSales & Marketing GroupElectronic Components IMagnetics Business GroWire-wound Inductors B				ness Company
APPROVED Person in charge	APPROV	/ED Pe	rson in charge	Person in charge
	H.Sasa	aki S	S.Sugimoto	C.Wang

CAUTION WHEN HANDLING

Before use the products, please read this specification.

CAUTION FOR SAFETY USING

When use the products, be careful to mentioned below for safety using.

CAUTION

- + The product should be used within 12 months.
 Be careful to the storage conditions. (Temperature : 5 to 30deg.C, Humidity : 75%RH Max.)
- Solderability might be decreased if the period is exceeded.
- + Do not use and store the product in condition of gas corrosion (Salt, Acid, Alkaline).
- + The products must be preheated before soldering.
- Difference between preheat and soldering temperature must be within 150deg.C.
- + Rework by soldering iron ; Please keep the mentioned conditions in this specification.
- + In case of insert P.C. Board on chassis, do not add mechanical stress to the product.
- + The product has self heat (temperature rise) by current, so keep margin for heat design.
- + Be careful to arrange of non-magnetic shield type inductors. The error may be caused by magnetic field coupling.
- + In case handle the products, please use wrist strap for ground static discharge on human body.
- + The product keeps away from magnet or magnetized things.
- + Do not use the product beyond the mentioned conditions in this specification.
- + About an application

The products listed on this specification sheet are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.

The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet.

- 1) Aerospace/Aviation equipment
- 2) Medical equipment
 - which directly endanger human life
- 3) Power-generation control equipment
- 4) Atomic energy-related equipment
- 7) Military equipment8) Safety equipment

6) Transportation control equipment

9) Other applications that are not considered general-purpose applications

5) Seabed equipment

If you intend to use the products in the following applications, please contact our sales office.

Transportation equipment (cars, electric trains, ships, etc.), Public information-processing equipment,

Electric heating apparatus / burning equipment, Disaster prevention/crime prevention equipment When using this product in general-purpose applications, you are kindly requested to take into consideration securing protection circuit/equipment or providing backup circuits, etc., to ensure higher safety.

	DWG.NO.	ISSUE	PAGE
TDK Corporation	C473NAA00103	1	1/8

CUSTOMER	TDK PART No.	CUSTOMER'S DWG. No.
FOXTAR	VLBS1007050T-R20M	

1,SCOPE

This specification applies to the high current type SMD inductors for VLBS1007050T-R20M

2,INDEX

Listed item	Attachment & Tables	Page
1, Shapes and Dimensions	Please see (1)	3/8
2, Electrical Schematics	Please see (2)	3/8
3, Characteristics	Please see (3)	3/8
4, Electrical Specifications	Please see (4)	4/8
5, Reliability Tests	Please see (5)	4/8,5/8,6/8
6, Land dimension(Ref.)	Please see (6)	6/8
7, Packaging	Please see (7)	6/8,7/8,8/8
8, Note	Please see (8)	8/8

9, Standard test conditions

Unless otherwise specified, test condition should be Temp. = 5 \sim 35 °C,

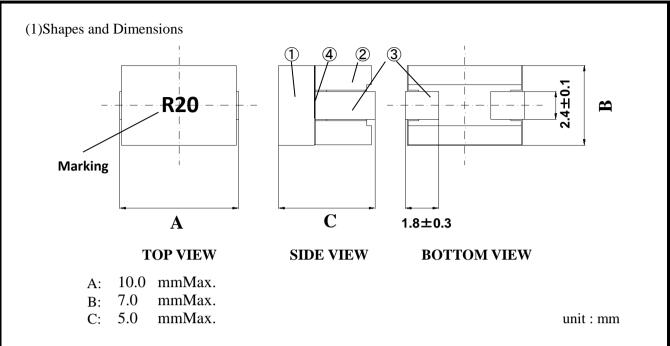
Humidity = $35 \sim 85\%$

But if needed , then test condition should be Temp. = 20 ± 2 °C, Humidity = $65\pm 5\%$.

3, Manufacturing Location

China

	DWG.No.	C473NAA00103	ISSUE 1	PAGE 2/8
TDK Corporation				



Note : It is OK if it is in the size standard even if the adhesive overflows.

(2)Electrical Schematics

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(3)Characteristics

- 3-1, Temperature rise : 40° C TYP. (Itemp)
- 3-2, Operating Temperature Range : -40°C to +125 °C (Including Self Temperature Rise)
- 3-3, Storage Temperature Range $:-40^{\circ}C$ to $+125^{\circ}C$
- 3-4, Rated current : Please see page 4 (Table 1)
- 3-5, Application

Reflow soldering can be used for this product while dip-flow can not.

The condition in soldering by hand should confirm to the heat capacitance corresponding to the test of resistance to soldering heat.

	4	Spacer	Resin beads			
	4	Glue	Epoxy resin			
	3	Wire and Terminal	Tin plated copper			
	2	Core 2	Ferrite			
	(1)	Core 1	Ferrite			
	No.	Item	Material			
	DWG.]	No. C473NAA001	.03 ISSUE 1	PAGE 3/8		
TDK Corporation						

(4)Electrical Specification

Table	1
1 auto	

Table 1						
Customer P#	TDK P#	Inductance	D.C.	*Rated current(A)		Marking
	VLBS1007050T	L(µH)	Resistance	Isat typ.	Itemp	
	-	at 100kHz	RDC(m-ohm)	@25°C	typ.	
	R20M	0.20±20%	0.22±10%	32	39	R20

*Rated current : the less value which is Isat or Itemp.

(Current is D.C.)

Isat : Based on inductance change(\triangle L:-30% from initial L value.)

Itemp : Based on temperature rise(\triangle T:40°C TYP.)

Test Instruments

L : 4294A IMPEDANCE/GAIN-PHASE ANALYZER, AGILENT OR EQUIV.

RDC : HP34420A MICRO OHM METER OR EQUIV.

L(Isat) : WK 3260B PRECISION MAGNETICS ANALYZER with WK 3265B 25A DC BIAS UNIT OR EQUIV.

(5)Reliability tests

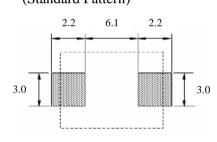
Т

No.	Test item	Test details				Spe	ecifi	cation
1	Temperature Characteristics		test shall be performed after the sample has ilized in an ambient temperature of -40 to $+125^{\circ}$ C.				$\leq \pm 1$	15%
2	Short time over load	1.5 times the ra	es the rated current for 5 minutes.			Their shal such as sn		no damage or sparks
3	Substrate bending	board and a load the arrow direct (Speed:0.5mm/s	d applied ion is ma s) ened up a F V	ered onto the printed circuit until the Figure in ade approximately 3mm. after 30 seconds. 10 - 2 5 ± 2 R5	20 	$\Delta L/L_0 \leq \pm$ There shat mechanica	ll be	no
		DWG	i.No.	C473NAA00103	ISS	SUE	1	PAGE 4/8
K Cor	poration	I						1

No.	Test item	Test details	Specification			
4	Resistance to	Temperature profile of reflow soldering	$\Delta L/L_0 \le \pm 10\%$			
-	Soldering heat	Pre-heating : 150~180°C 60~120sec.	There shall be no			
	-	-				
	(reflow soldering)	Peak temperature : $260\pm3^{\circ}$ C 5sec.or less	mechanical damage			
		Holding time: 230°C or over ,30~60sec.				
		300°C— Peak 260±3°C 250°C— 230°C MIN.				
		200°C Pre-heating Slow cooling				
		150°C				
		100°C				
		50°C/				
		0°C				
		120 sec.MAX 30 sec.MIN				
		*The specimen shall be passed through the reflow oven with	ith			
		the condition shown in the above profile for 2 times.				
		*The specimen shall be stored at standard atmospheric con	nditions			
		for 24 hours, after which the measurement shall be made.				
		*Test Board : t=1.6mm glass-epoxy type.				
		*Above profiles were measured at the solder paste part.				
		*Solder Paste : M705-12B(Senju Metal Industry) or equiv	·.			
	Resistance to	Manual soldering	$\Delta L/L_0 \le \pm 5\%$			
	soldering heat	Solder Temperature : $400\pm3^{\circ}$ C	There shall be no			
		Dip time : $3+1/-0s$				
	(manual soldering)	-	mechanical damage			
		Depth : From the min body bottom to 1mm.				
5	Solderability	Precondition : Steam aging 4h or PCT105°C, 100%RH4H	New solder more			
		Flux : Rosin, isopropyl alcohol	than 90%			
		Solder : M705(Senju metal industry)				
		Temperature: 245±3℃				
		Dip time : 3±0.2s				
6	Low temperature	The sample will be left for 500 ± 4 hours in an	$\Delta L/L_0 \le \pm 5\%$			
-	storage	atmosphere with a temperature of $-40\pm3^{\circ}$ C.	There shall be no			
	8-	Upon completion of the test the measurement shall be	mechanical damage			
		made after the sample has been left in a normal				
		temperature and normal humidity for 1hour.				
7	TT' 1 .					
7	High temperature	The sample shall be left for 500 ± 4 hours in an	$\Delta L/L_0 \le \pm 5\%$			
	storage	atmospere with a temperature of $125\pm2^{\circ}C$ and a normal	There shall be no			
		humidity. Upon completion of the measurement shall be	mechanical damage			
		made after the sample has been left in normal temperature				
		and normal humidity for 1 hour.				
8	Moisuture storage	The sample shall be left for 500 ± 4 hours in a	$\Delta L/L_0 \le \pm 5\%$			
		temperature of 60±2°C and a humidity (RH) of 90 to 95%.	There shall be no			
		Upon completion of the test, the measurement shall be ma	de mechanical damage			
		after the sample has been left in a normal temperature and	_			
		normal humidity more than 1 hour.				
			¹			
		DWG.No. C473NAA00103 IS	SUE 1 PAGE 5/8			

No.	Test item		Test details	3	Specification
9	Change of	The sample	shall be subject to 500 c	ycles,	$\Delta L/L_0 \le \pm 5\%$
	temperature	such as show	vn in the Table 2 below a	nd then it shall be	There shall be no
	-	subjected to	standard atmospheric con	nditions for 1 hour ,	mechanical damage
		after which i	neasurement shall be made	de.	
		Та	ble 2		
			Temperature	Duration	
		1	-40°C	30min.	
			\$		
		2	+125°C	30min.	
10	Vibration	Vibration fre	equency : 10Hz to 500Hz		$\Delta L/L_0 \le \pm 5\%$
		Double amp	litude : 1.5mm P-P		There shall be no
		5h	mechanical damage		
11	Shock	Acceleration	$: 1000 \text{m/s}^2$	$\Delta L/L_0 \le \pm 5\%$	
		Duration	pulse)	There shall be no	
		Direction an	d Number of time : X,Y,	Z,X',Y',Z' each 3 times	mechanical damage
			Total	18 times	

(6)Land dimension(ref.) (Standard Pattern)

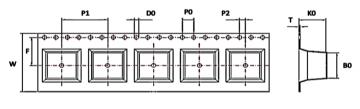


unit : mm

Neighboring copper parts, for example the lines from land, be land, be treated with resist.

(7) Packaging

7-1, Carier type dimemsions



	No.	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	
	Spec.	7.2	10.2	5.2	4.0	16.0	
	No.	P2 (mm)	W (mm)	T (mm)	F (mm)	D0 (mm)	
	Spec.	2.0	24±0.3	0.5±0.05	11.5	1.5+0.1/-0	
		DWG.I	No. C4	473NAA001	.03 I	SSUE 1	PAGE 6/8
TDK Corporatio	n						

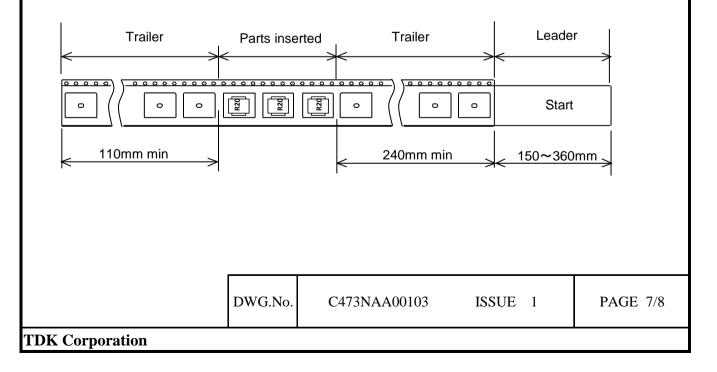
		(-ж-Е	φC		W2	φB	
		R	φι				V1	
							unit : i	mm
φA	φB	фC	φD	Е	W	W1	W2	R
330±2	100±1.0	13.0±0.5	21.2±0.8	2.0±0.5	24.4 +2/-0	2.0±0.5	30.4 or less	(1.0)

7-4, Marking : The following items shall be marked each unit park.

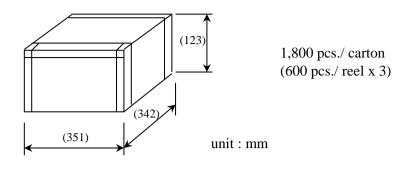
- 1, Customer P# 4, Inspection No. 2, TDK P# 5, Quantity 3, TDKP# cord
 - 6, Manufacturing location

7-5, The products are packaged so that no damage will be sustained.

7-6, Taping dimensions



7-7, Dimensions of carton



(8) Note

- 8-1. If there occurs something to be discussed, it should be treated on deliberation between customer and TDK Corporation.
- 8-2. Please don't use the product that experienced falling.However, If the falling is from less than 20cm high to vinyl-tile-like ground, The product with normal appearance and characteristics can be used.
- 8-3. Please don't apply the stress more 10N onto the top of the product.(Cause of ferrite core damage)
- 8-4. If acoustic noise was occurred by magnetostrictive, it is preferable that reject or attenuate the audible frequency of current.

	DWG.No.	C473NAA00103	ISSUE 1	PAGE 8/8
TDK Corporation				-